
Architecting High Performance Computing Systems for Fault Tolerance and Reliability

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Agenda

- HPC Fault Tolerance and Reliability
- Architecture Design Techniques
- Dell HPC Solutions: Purpose Built Reliability
- Questions

HPC Fault Tolerance and Reliability

HPC Fault Tolerance and Reliability

- Complex nature of HPC systems can have a detrimental effect on their ability to reliably complete the tasks at hand.
- Research performed by HPC systems is important!
- Reliability and fault tolerance is of utmost concern in HPC.

$$MTTF = \int_0^{\infty} R(t).dt$$

$$MTTF = \int_0^{\infty} e^{-\lambda t}.dt$$

$$A = \frac{MTTF}{MTTR + MTTF}$$

Single Points of Failure



- Shared-memory multiprocessor (SMP) systems are generally prone to system wide failures due to single errors in memory, CPU or disk.
- With the ubiquitous use of clustered HPC technology in the last decade, the risk of system wide failures due to single points of failure can be minimized!
- Clustered solutions must be designed correctly.

HPC Subsystem Design

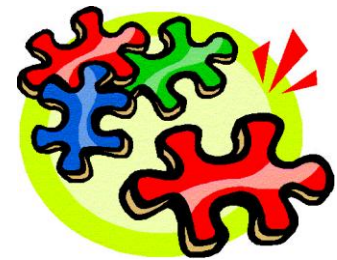
- Cluster solutions have many “moving parts”
- It is important to design each subsystem with an eye to how it relates to the other subsystems.
- Find key components that are likely to cause system wide failures, and implement architecture design techniques to prevent such failures.



Architecture Design Techniques

Component Classification

- Failure has little effect on overall reliability
 - Compute Nodes
 - Out-of-band management
- Failure has major effect on overall reliability
 - Head / Admin Node(s)
 - Job Scheduler
 - Storage
 - Power
 - Cooling
 - Cabling
 - Network
 - The list goes on...



Compute Nodes



- Irony: The workhorse subsystem of an HPC cluster, is the same subsystem that requires the least amount of built-in fault tolerance.
- High fault tolerance to an occasional failed job
- Generally does not require added fault tolerant subsystems

Compute Nodes



- Common to have several compute nodes inoperable on large systems
- When a single compute node fails, typically only one job is effected, or subset of jobs, on the system.

Login Nodes



- Customer Facing, Outage Perception
- Provide Multiple Identical Nodes
- Publish Entry Points

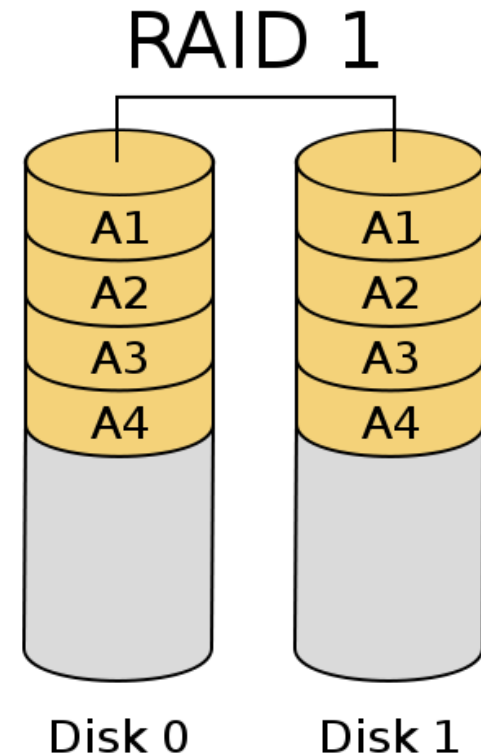
Head / Administrative Nodes



- Consider Separating these Functions
 - Provisioning
 - Image Management
 - Job Scheduling (Multiple Nodes!)
 - Network Boot for Compute Nodes

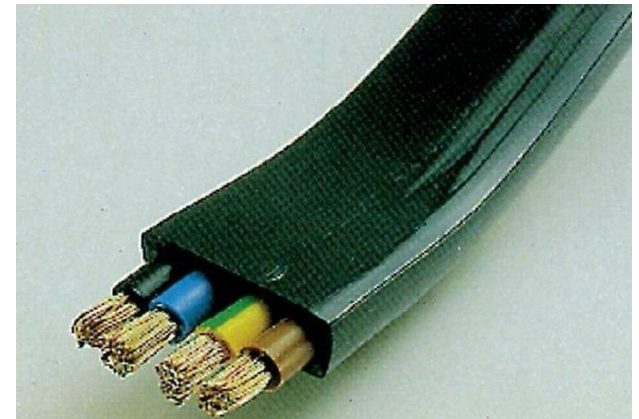
Non-Compute Node Disk Protection

- Mirroring - RAID 1 (this doesn't protect against data corruption though)
- Hot Spares
- Backups (software stack, compute node images)
- Disk Cloning (weekly, multiple copies)



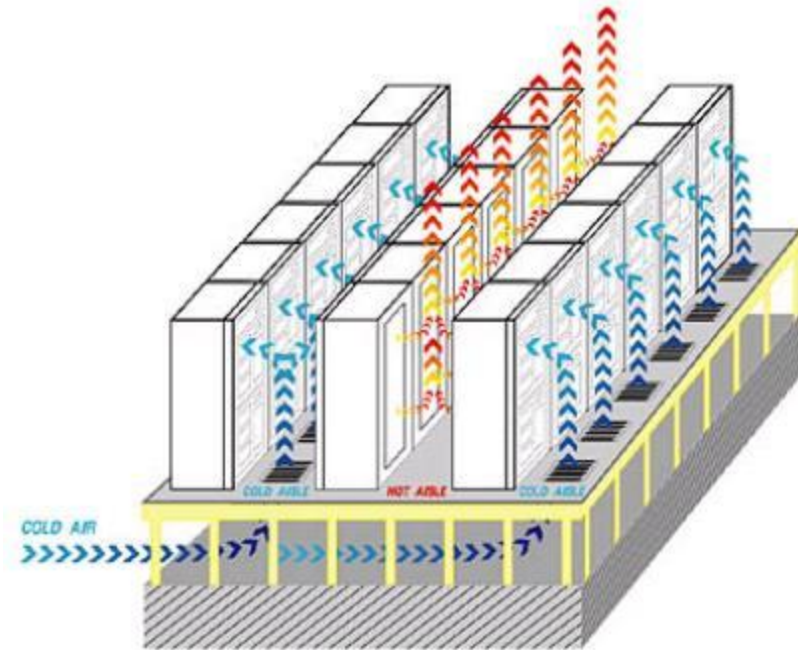
Power Distribution

- Continuous Power Feed
 - Generators
 - Battery Backup or UPS
- Multiple Data Center or Rack based PDUs
- Deliver Power Feeds to Multiple Power Supplies
- Hot Swapable Power Supplies
- Labeling is critical



Cooling

- For every watt consumed in a component, there is a cooling power component that must be consumed as well!
- Air Handlers, Chillers, Fans
- Hot spots correlate with compute nodes
- Hot/Cold Aisles
- Chilled Doors, In-row cooling



Job Scheduling

Queue	Memory	CPU Time	Walltime	Node	Run	Que	Lm	State
batch	--	--	--	--	0	0	--	E R
staff	--	--	720:00:0	12	8	0	--	E R
student_long	--	--	240:00:0	4	4	0	16	E R
student_short	--	--	04:00:00	8	0	0	10	E R
dedicated	--	--	00:30:00	1	0	0	1	E R
student_medium	--	--	24:00:00	4	4	0	10	E R
					16	0		

- “Job Scheduling State” database
- Multiple paths to the database
- Multiple failover daemons on separate nodes
- Jobs may continue to run on compute node infrastructure, even if daemon nodes fail. But you need a “map” of the activity.
- Checkpoint / Restart

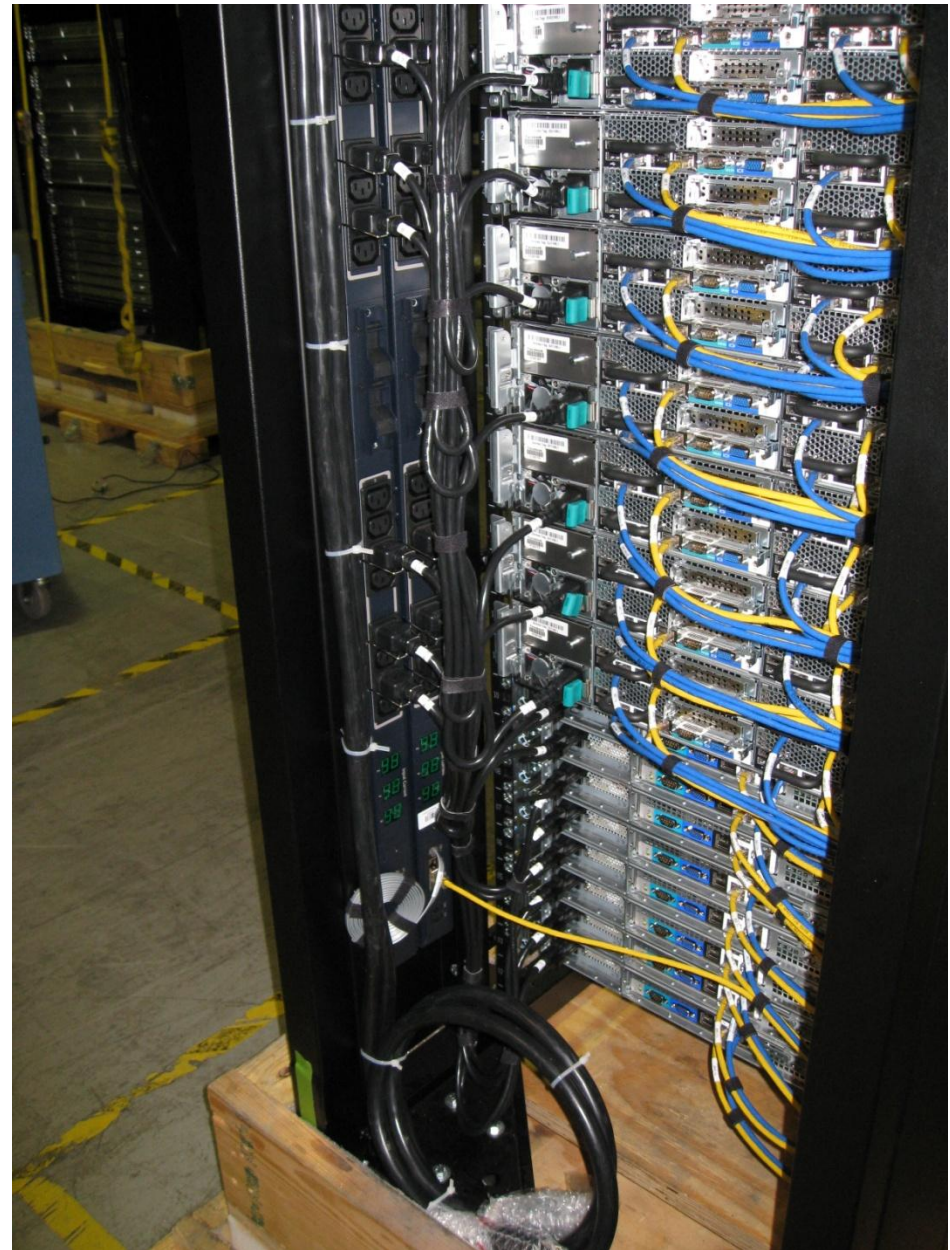
Networking and Interconnect

- Little redundancy needed in admin network
- Out-of-band management is crucial
- Interconnect hubs require redundancy
 - Ethernet & Infiniband
 - MPI / Storage
 - Power
 - Uplinks/Downlinks



Cable Management

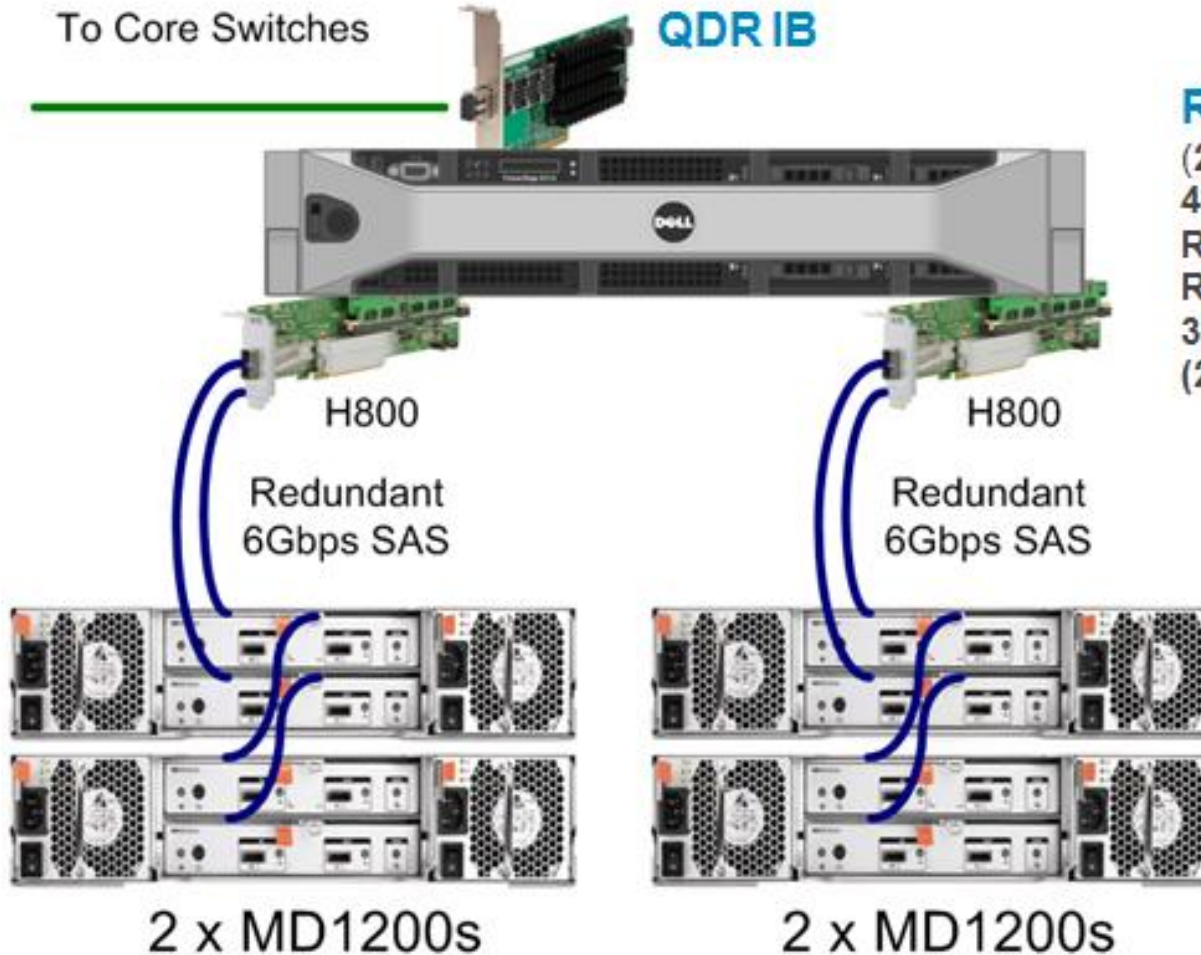
- Reliability, Really?
- Heavy IB Cables
- Labeling is Critical
- Organize the chaos
- You'll be glad next time you have a outage and time is of the essence!



Continual Testing!

Dell HPC Solutions: Purpose Built Reliability

The Dell HPC NFS Storage Solution (NSS)



R710: (NFS Gateway)

(2) 2.4GHz Westmere (4c)
48GB memory
RAID-1 OS w/ host-spare
RAID-0 swap (2 drives)
3 years support including FS
(2) PERC H800 w/ RAID-60 and LVM

Summary

48-96TB

RAID-60 and LVM

RAID-6 within each MD1200

RAID-0 across MD1200's

LVM to combine LUNS

10GigE NFS Performance

Sequential Read: 855 MB/s

Sequential Write: 1,180 MB/s

InfiniBand NFS Performance

Sequential Read: 1,350 MB/s

Sequential Write: 1,470 MB/s

Behind the Bezels (BTB)

QDR IB or 10GigE (PCIe x8 slot)



H800
PCIe x8
slot

H800
PCIe x4
slot

Redundant
6Gbps SAS

Redundant
6Gbps SAS

R710: (NFS Gateway)

(2) 2.4 GHz Westmere (4c)
48GB memory

RAID-1 OS w/ hot spare

(3) 146GB 10K 2.5" SAS

RAID-0 for swap

(2) 146GB 10K 2.5" SAS

Allows for much faster file system check

3 years support including FS
H800 w/ RAID-60 and LVM

12 drives in RAID-6 per

MD1200 (no hot spare)

RAID-0 across both MD's per H800

LVM to combine LUNs

Capacity:

96TB before formatting

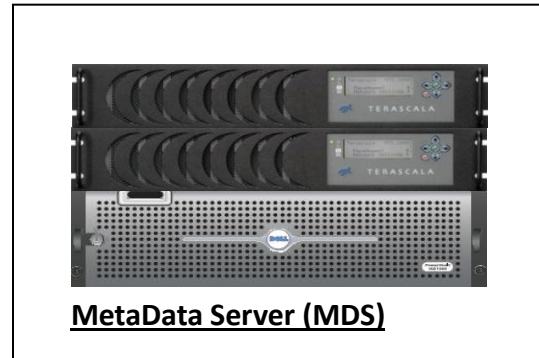
80TB after RAID

78.4TB after formatting



The Dell Terascale HPC Storage Solution (HSS)

- Full Lustre solution, fully configured, tested, tuned, and deployed
 - On-site installation with client deployment and training included
- Redundant, highly available solution
- Simple, linear scalability
- Full management system with easy to use GUI



Dell PowerEdge C6100

- **Four 2-Socket Nodes in 2U**
 - Intel Westmere-EP
- **Each Node:**
 - 12 DIMMs each
 - 2 GigE (Intel)
 - 1 Daughter Card (PCIe x8)
 - 10GigE
 - QDR IB
 - One PCIe x16 (half-length, half-height)
 - Optional SAS controller (in-place of IB)
- **Chassis Design:**
 - Hot Plug, Individually Serviceable System Boards / Nodes
 - Up to 12 x 3.5" drives (3 per node)
 - Up to 24 x 2.5" drives (6 per node)
- **N+1 Power supplies (1100W or 1400W)**
- **NVIDIA HIC certified**
- **DDR and QDR IB PCIe card certified**



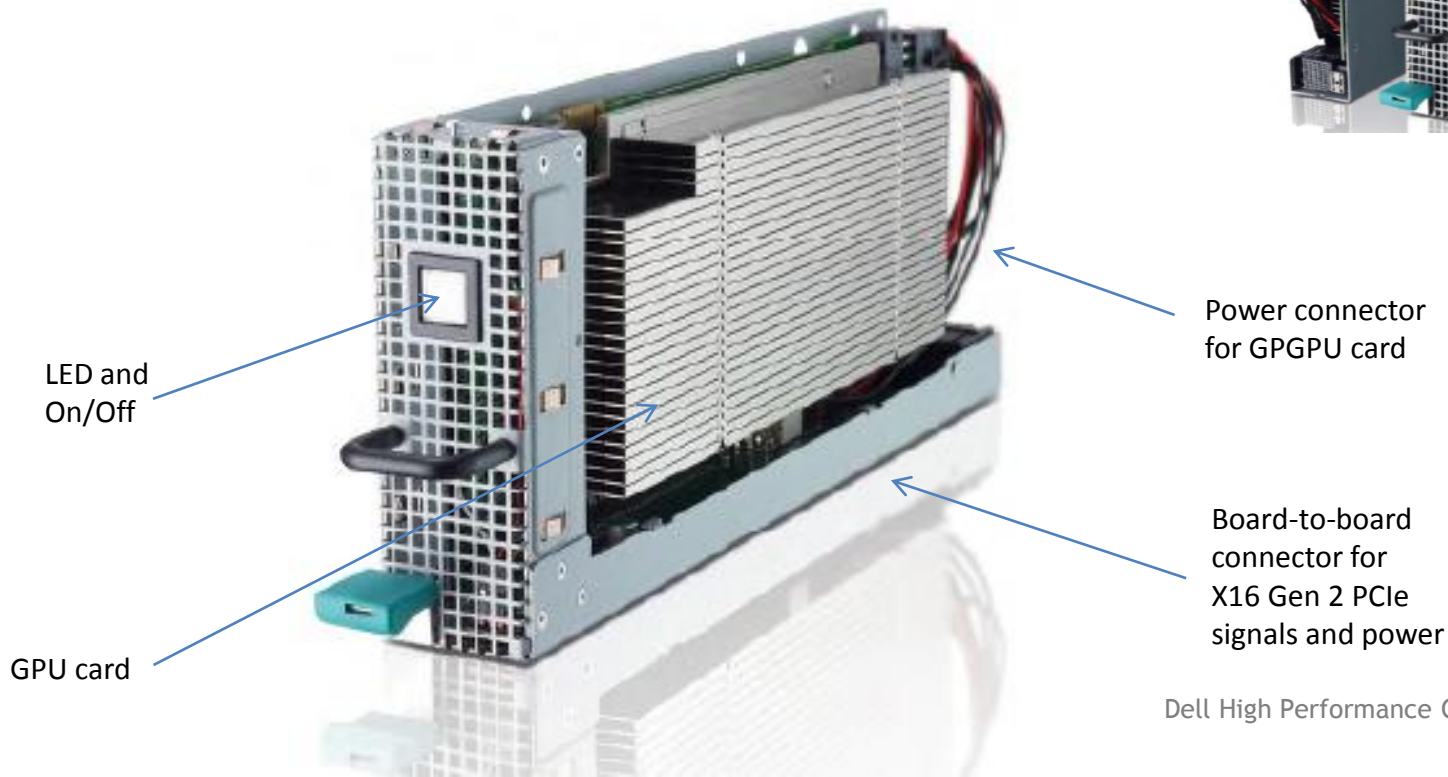
Dell PowerEdge C410x

- 3U chassis (external)
 - “Room-and-Board” for PCIe Gen-2 x16 devices
 - Up to 8 hosts
- Sixteen (16) x16 Gen-2 Devices
 - Initial Target = GPGPUs
 - Support for any FH/HL or HH/HL device
 - Each slot Double-Wide
 - Individually Serviceable
- N+1 Power (3+1)
 - Gold (90%)
- N+1 Cooling (7+1)



Dell PowerEdge C410x

- Sixteen (16) x16 Gen-2 Modules
 - PCIe Gen-2 x16 compliant
 - Independently serviceable



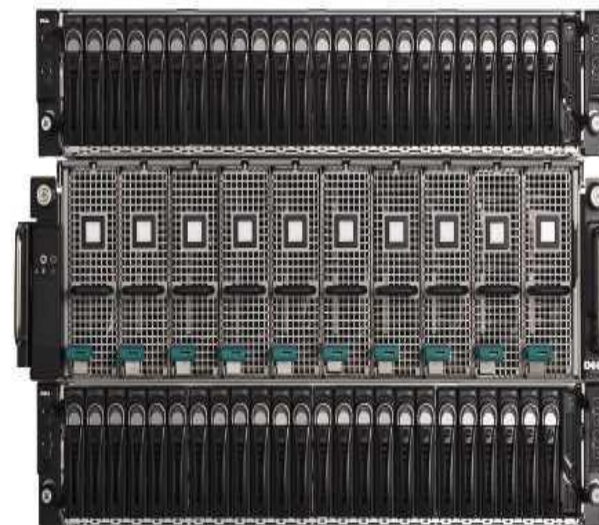
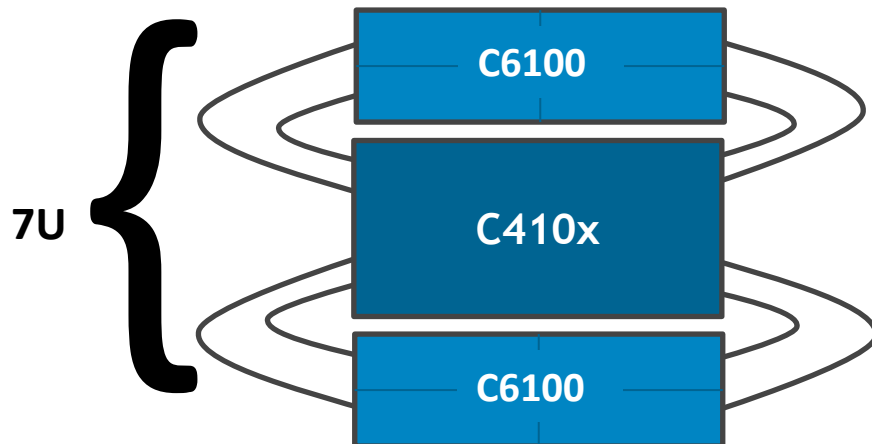
LED and
On/Off

GPU card

Power connector
for GPGPU card

Board-to-board
connector for
X16 Gen 2 PCIe
signals and power

C410x “Sandwich”



8-Card C410x Sandwich		16-Card C410x Sandwich
2 x C6100		2 x C6100
8 GPUs		16 GPUs
1 - QDR IB daughtercard		1 - QDR IB daughtercard
7U total		7U total
8 GPUs total		16 GPUs total
8 nodes total		8 nodes total
8/7 nodes / U		8/7 node / U
8/7 GPUs per U		16/7 GPUs per U
1 GPU per PCIe x16		2 GPUs per PCIe x16

Dell PowerEdge C410x

- Increased density (more GPUs per RackU)
- Introduced “flexibility”
 - GPU/Host ratio = 1:1, 2:1, 3:1, 4:1, ..., (8:1), ..., (16:1)
- Purposely Separate the Host from the GPUs
- Purpose-built to power, cool and manage PCI-e devices
 - (N+1) Power (3+1 “Gold” power supplies)
 - (N+1) Cooling (7+1 fans)
 - Onboard BMC Web interface to monitor, manage & configure
 - Each PCI-e Module is individually serviceable
 - no un-cabling
 - no un-racking
 - - no opening of compute nodes
 - - no bumped DIMMS
 - - no disturbed dust
 - - vertical insertion



HPC at Dell

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